ABSOLATION CONNECTING ELECTRONICS INDUSTRIES OF INTERNATIONAL AND ADDRESS OF	annockburn, Ill	linois. All rights reserved u	nder both	This docume level parts, t	ent is a declara he declara	ntion of the su encompasse	ubstances s all lower	within the manufacture level materials for wh	er listed ite	em. Note: if nufacturer h	the item is an as	sembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribution			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information			
Supplier Information												
Company name*	pany unique ID	que ID U			Unique ID Authority				Response Date*			
onsemi	isemi								2023-06-08			
Dontact Name Title - Contact]	Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Enviro Compliance					NA				Product-Env-Stewards@onsemi.com			
athorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number N	Afr Item Numb	ber Mfr Item Name	Mfr Item Name		Effective Date Version Manufacturing Site		Ianufacturing Site	W	eight*	UOM	Unit Type	
F	OD3125S	8PW 2.5A GD D	PW 2.5A GD DIP		2023-06-08		I	LITEONFG		98.1311	mg	Each
Manufacturing Proccess Information		L									I	I
Terminal Plating / Grid Array Material	Termina	al Base Alloy	J-STD-020 MSI	L Rating	Peak Pro	k Process Body Temperature Max Time at Per		e Max Time at Peak	CTemperature Number		r of Reflow Cyc	les
Precious metal (e.g. Ag,Au, NiPdAu) Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn) CU Alloy		1		260 C		C	30 seco		econds 3		
Comments												
evel 1 - maximum time at peak temperature du	ring soldering	g is 10-30 seconds										
for more information regarding material comp	osition please	refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	113.416	mg	Supplier	Zinc (Zn)	7440-66-6		0.1361	mg
			Supplier	Iron (Fe)	7439-89-6		2.6653	mg
			Supplier	Copper (Cu)	7440-50-8		110.5806	mg
			Supplier	Phosphorus (P)	7723-14-0		0.034	mg
Die	1.131	mg	Supplier	Silicon (Si)	7440-21-3		1.131	mg
Die Attach	0.25	mg	Supplier	Silver (Ag)	7440-22-4		0.205	mg
			Supplier	Dicyandiamine	461-58-5		0.0025	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0425	mg
Mold Compound-White	459.747	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		114.9368	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		13.7924	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		62.0658	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		13.7924	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		229.8735	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		25.2861	mg
Plating	1.58413	mg	Supplier	Silver (Ag)	7440-22-4		0.0242	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0566	mg
			В	Nickel (Ni)	7440-02-0		1.471	mg
			Supplier	Gold (Au)	7440-57-5		0.0323	mg
Protective Coating	6.13	mg	Supplier	Poly(dimethylsiloxane), hydroxy terminated	70131-67-8		3.065	mg
			Supplier	Ethylbenzene	100-41-4		0.613	mg
			Supplier	Filler (SiO2)	68909-20-6		1.1647	mg
			Supplier	Misc.	Proprietary Data		0.0613	mg
			Supplier	Xylene	1330-20-7		1.226	mg
Wire Bond - Au	15.873	mg	Supplier	Gold (Au)	7440-57-5		15.873	mg